

OKI

semiconductor

DECEMBER 1983

MSM5832 MICROPROCESSOR REAL-TIME CLOCK/CALENDAR

MSM5832 MICROPROCESSOR REAL-TIME CLOCK/CALENDAR

GENERAL DESCRIPTION

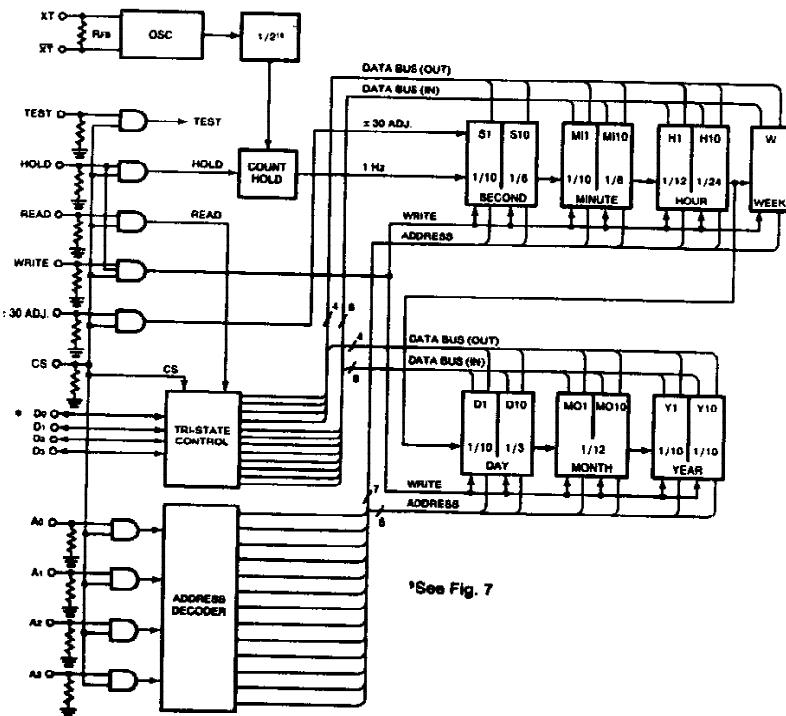
The MSM5832 is a monolithic, metal-gate CMOS integrated circuit that functions as a real time clock/calendar for use in bus-oriented microprocessor applications. The on-chip 32.768 Hz crystal controlled oscillator time base is counted down to provide addressable 4-bit I/O data of SECONDS, MINUTES, HOURS, DAY-OF-WEEK, DATE, MONTH, and YEAR. Data access is controlled by 4-bit address, chip select, read, write and hold inputs. Other functions include 12H/24H format selection, leap year identification and manual ± 30 second correction.

The MSM5832 normally operates from a 5 volt $\pm 5\%$ supply. Battery back-up operation down to 2.2 volts allows continuation of time keeping when main power is off. One test input facilitates rapid testing of the time keeping operations. The MSM5832 is offered in an 18-lead dual-in-line plastic (RS suffix) package.

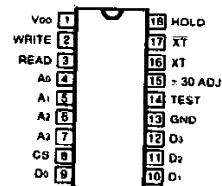
FEATURES

- Microprocessor bus-oriented
- TIME MONTH DATE YEAR DAY OF WEEK
23:59:59 12 - 31 - 99 - 7
- 4-BIT DATA BUS
- 4-BIT ADDRESS
- Read, Write, Hold, Chip select inputs
- Interrupt signal outputs—1024, 1, 1/60, 1/3600 Hz
- 32.768 KHz crystal controlled operation
- Leap year register bit
- 12 or 24 hour format
- ± 30 second error correction
- Single 5 volt power supply
- Back-up battery operation to VDD=2.2 V
- Low Power Dissipation
90 μ w Max. at VDD=3 V
2.5 mw Max. at VDD=5 V
- High Density 300 mil 18-Pin Package

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION



A0 to A3: Address Inputs

WRITE: Write Enable

READ: Read Enable

HOLD: Count Hold Enable

CS: Chip Select

D0 to D3: Data Input/Output

TEST: Test Input

± 30 ADJ: ± 30 Second Correction Input

XT & XT: xtal oscillator connections

Vdd: +5 V Supply

GND: Ground

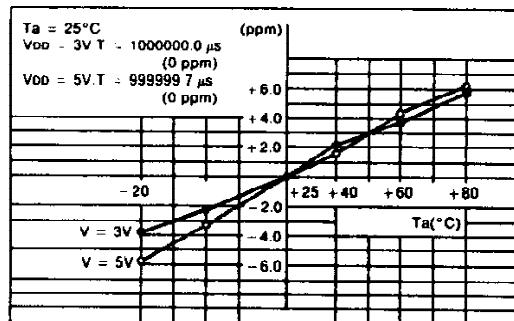
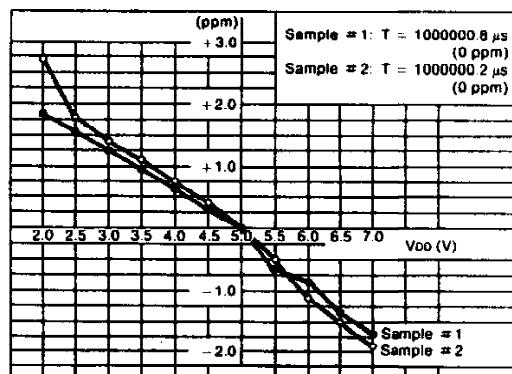
FUNCTION TABLE**FIGURE 1**

ADDRESS INPUTS				INTERNAL COUNTER	DATA I/O				DATA LIMITS	NOTES
A ₀	A ₁	A ₂	A ₃		D ₀	D ₁	D ₂	D ₃		
0	0	0	0	S 1	*	*	*	*	0 ~ 9	
1	0	0	0	S 10	*	*	*	*	0 ~ 5	
0	1	0	0	M 1	*	*	*	*	0 ~ 9	
1	1	0	0	M 10	*	*	*	*	0 ~ 5	
0	0	1	0	H 1	*	*	*	*	0 ~ 9	
1	0	1	0	H 10	*	*	†	†	0 ~ 1 0 ~ 2	D ₂ = "1" for PM D ₃ = "1" for 24 hour format D ₂ = "0" for AM D ₃ = "0" for 12 hour format
0	1	1	0	W	*	*	*	*	0 ~ 6	
1	1	1	0	D 1	*	*	*	*	0 ~ 9	
0	0	0	1	D 10	*	*	†		0 ~ 3	D ₂ = "1" for 29 days in month 2 D ₂ = "0" for 28 days in month 2 (2)
1	0	0	1	M 0 1	*	*	*	*	0 ~ 9	
0	1	0	1	M 0 10	*				0 ~ 1	
1	1	0	1	Y 1	*	*	*	*	0 ~ 9	
0	0	1	1	Y 10	*	*	*	*	0 ~ 9	

(1) *data valid as "0" or "1"

blank does not exist (unrecognized during a write and held at "0" during a read)
pdata bits used for AM/PM, 12/24 HOUR and leap year must be masked from the H10 and D10 registers for correct time to be read.

(2) If D2 previously set to "1", upon completion of month 2 day 29, Q2 will be internally reset to "0"

TYPICAL CHARACTERISTICS—Oscillator Frequency Deviations**Frequency Deviation vs Temperature****Frequency Deviation vs Supply Voltage****FIGURE 2****FIGURE 3****ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Supply Voltage	V _{DD}	-0.3 ~ 7.0	V
Input Voltage	V _{IN}	-0.3 ~ V _{DD} + 0.3	V
Data I/O Voltage	V _O	-0.3 ~ V _{DD} + 0.3	V
Storage Temperature	T _{stg}	-55 ~ 150	°C

Note: Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.